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Attorney Docket No. 108298705US Disclosure No. 02-1607

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TDANIONNITTAL			Application Number	10/005,219	
_	MITTAL		Filing Date	September 17, 2003	
FO	RM		First Named Inventor	Whonchee Lee	
(to be used for all correspondence after initial filing)		Art Unit	3723 /		
		-	Examiner Name	Dung V. Nguyen	
Total Number of Pages in	n This Submission	9*	Attorney Docket Number	108298705US	
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Affidavits/decla	ration(s)	_			,
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Express Abandonmo	ent Request	☐ Term	inal Disclaimer	Status Letter	
Information Disclosu	re Statement	Request for Refund		Other Enclosures: 1) Form PTO-1449;	
_		_		2) Cited References (28);	
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Response to Missing Parts/ Incomplete Application		Remarks	6		
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Individual name	M. Wechkin stration No. 42,216	,	1		
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Date: March 19, 2004

By: Stephen P. Whelan

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

WHONCHEE LEE ET AL.

EXAMINER:

DUNG V. NGUYEN

APPLICATION NO.:

10/665,219

ART UNIT:

3723

FILED:

SEPTEMBER 17, 2003

CONF. NO:

6284

For:

METHODS AND APPARATUS FOR REMOVING CONDUCTIVE MATERIAL

FROM A MICROELECTRONIC SUBSTRATE

<u>Information Disclosure Statement Within Three Months of</u>
<u>Application Filing or Before First Action – 37 C.F.R. § 1.97(b)</u>

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

1. Timing of Submission

This information disclosure is being filed within three months of the filing date of this application or date of entry into the national stage of an international application or before the mailing date of a first Office action on the merits, whichever occurs last [37 C.F.R. § 1.97(b)]. The references listed on the enclosed Form PTO-1449 (modified) may be material to the examination of this application; the Examiner is requested to make them of record in the application.

2. <u>Cited Information</u>

\boxtimes	Copies of the following references are enclosed	d:
		•
	☐ All cited references	

⊠ References marked by two asterisks (**)

This application was filed after 30 June 2003 and no copies of U.S. patents nor published applications are enclosed (See Notice of Deputy Commissioner Kunin on 11 July 2003).

The following references are not in English. For each such reference, the undersigned has enclosed (i) a translation of the reference; (ii) a copy of a communication from a foreign patent office or International Searching Authority citing the reference, (iii) a copy of a reference which appears to be an English-language counterpart, or (iv) an English-language abstract for the reference prepared by a third party. Applicant has not verified that the translation, English-language counterpart or third-party abstract is an accurate representation of the teachings of the non-English reference, though, and reserves the right to demonstrate otherwise.

☐ All cited references

3. Effect of Information Disclosure Statement (37 C.F.R. § 1.97(h))

This Information Disclosure Statement is not to be construed as a representation that: (i) a search has been made; (ii) additional information material to the examination of this application does not exist; (iii) the information, protocols, results and the like reported by third parties are accurate or enabling; or (iv) the cited information is, or is considered to be, material to patentability. In addition, applicant does not admit that any enclosed item of information constitutes prior art to the subject invention and specifically reserves the right to demonstrate that any such reference is not prior art.

4. <u>Fee Payment</u>

No fees are believed due because this Information Disclosure Statement is being filed before the mailing date of the first Office Action.

However, should the Commissioner determine that fees are due in order for this Information Disclosure Statement to be considered, the Commissioner is hereby authorized to charge such fees to Deposit Account No. 50-0665.

Date: March 19 604

John M. Wechkin Registration No. 42,216

Respectfully submitted, Perkins Coie LLP

Correspondence Address:

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Perkins Coie LLP
P.O. Box 1247
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(206) 359-8000



Sheet

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

Form PTO-1449 (Modified) (Use several sheets if necessary)

of

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	C	COMPLETE IF KNOWN
Application Number		10/665,219
	Confirmation Number	6284
	Filing Date	September 17, 2003
	First Named Inventor	Whonchee Lee
	Group Art Unit	3723
	Examiner Name	Dung V. Nguyen
	Attorney Docket No.	108298705US

			U	.S. PATENT DOCUMENTS		
Examiner Initials*	Cite No.	U.S. Patent or Application	on Kind Code (if known)	Name of Patentee or Inventor of Cited Document	Date of Publication or Filing Date of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
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COMPLETE IF KNOWN Application Number 10/665,219 **INFORMATION DISCLOSURE** Confirmation Number 6284 STATEMENT BY APPLICANT Filing Date September 17, 2003 Form PTO-1449 (Modified) First Named Inventor Whonchee Lee (Use several sheets if necessary) 3723 Group Art Unit Examiner Name Dung V. Nguyen Sheet 6 of 6 Attorney Docket No. 108298705US

		OTHER PRIOR ART-NON PATENT LITERATURE DOCUMENTS	
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